



## HIGH OUTPUT FULL-DUPLEX RS-485 DRIVERS AND RECEIVERS

### FEATURES

- 1/8 Unit-Load Option Available (Up to 256 Nodes on the Bus)
- Bus-Pin ESD Protection Exceeds 15 kV HBM
- Optional Driver Output Transition Times for Signaling Rates <sup>(1)</sup> of 1 Mbps, 5 Mbps and 25 Mbps
- Low-Current Standby Mode < 1  $\mu$ A
- Glitch-Free Power-Up and Power-Down Bus I/Os
- Bus Idle, Open, and Short Circuit Failsafe
- Meets or exceeds the requirements of ANSI TIA/EIA-485-A and RS-422 Compatible
- 3.3-V Devices available, SN65HVD30-39

### APPLICATIONS

- Utility Meters
- Chassis-to-Chassis Interconnects
- DTE/DCE Interfaces
- Industrial, Process, and Building Automation
- Point-of-Sale (POS) Terminals and Networks

### DESCRIPTION

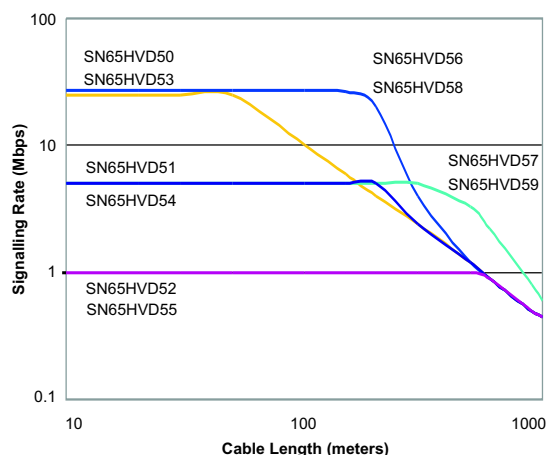
The SN65HVD5X devices are 3-state differential line drivers and differential-input line receivers that operate with a 5-V power supply. Each driver and receiver has separate input and output pins for full-duplex bus communication designs. They are designed for balanced transmission lines and interoperability with ANSI TIA/EIA-485A, TIA/EIA-422-B, ITU-T v.11 and ISO 8482:1993 standard-compliant devices.

(1) The signaling rate of a line is the number of voltage transitions that are made per second expressed in the units bps (bits per second).

The SN65HVD50, SN65HVD51, SN65HVD52, SN65HVD56 and SN65HVD57 are fully enabled with no external enabling pins. The SN65HVD56 and SN65HVD57 implement receiver equalization technology for improved performance in long distance applications.

The SN65HVD53, SN65HVD54, SN65HVD55, SN65HVD58, and SN65HVD59 have active-high driver enables and active-low receiver enables. A very low, less than 1  $\mu$ A, standby current can be achieved by disabling both the driver and receiver. The SN65HVD58 and SN65HVD59 implement receiver equalization technology for improved performance in long distance applications.

All devices are characterized for operation from -40°C to +85°C.



The SN65HVD56 and SN65HVD58 implement receiver equalization technology for improved jitter performance on differential bus applications with data rates up to 20 Mbps at cable lengths up to 160 meters.

The SN65HVD57 and SN65HVD59 implement receiver equalization technology for improved jitter performance on differential bus applications with data rates in the range of 1 to 5 Mbps at cable lengths up to 1000 meters.



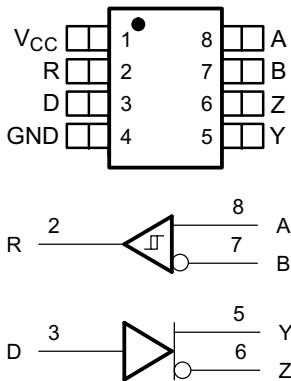
Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

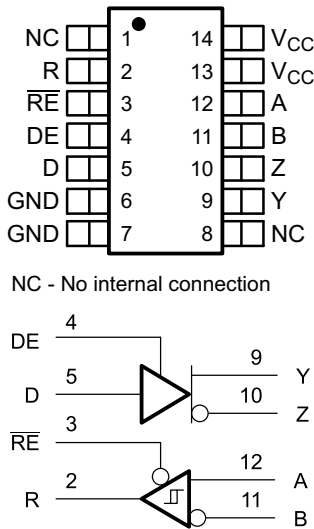
**SN65HVD50, SN65HVD51, SN65HVD52, SN65HVD56,  
SN65HVD57**

D PACKAGE (TOP VIEW)



**SN65HVD53, SN65HVD54, SN65HVD55, SN65HVD58,  
SN65HVD59**

D PACKAGE (TOP VIEW)



NC - No internal connection

**AVAILABLE OPTIONS**

| SIGNALING RATE | UNIT LOADS | RECEIVER EQUALIZATION | ENABLES | BASE PART NUMBER | SOIC MARKING |
|----------------|------------|-----------------------|---------|------------------|--------------|
| 25 Mbps        | 1/2        | No                    | No      | SN65HVD50        | PREVIEW      |
| 5 Mbps         | 1/8        | No                    | No      | SN65HVD51        | PREVIEW      |
| 1 Mbps         | 1/8        | No                    | No      | SN65HVD52        | PREVIEW      |
| 25 Mbps        | 1/2        | No                    | Yes     | SN65HVD53        | 65HVD53      |
| 5 Mbps         | 1/8        | No                    | Yes     | SN65HVD54        | 65HVD54      |
| 1 Mbps         | 1/8        | No                    | Yes     | SN65HVD55        | 65HVD55      |
| 25 Mbps        | 1/2        | Yes                   | No      | SN65HVD56        | PREVIEW      |
| 5 Mbps         | 1/8        | Yes                   | No      | SN65HVD57        | PREVIEW      |
| 25 Mbps        | 1/2        | Yes                   | Yes     | SN65HVD58        | PREVIEW      |
| 5 Mbps         | 1/8        | Yes                   | Yes     | SN65HVD59        | PREVIEW      |

## ABSOLUTE MAXIMUM RATINGS

over operating free-air temperature range (unless otherwise noted)<sup>(1)(2)</sup>

|          |                                                                                                 | UNIT               |
|----------|-------------------------------------------------------------------------------------------------|--------------------|
| $V_{CC}$ | Supply voltage range                                                                            | –0.3 V to 6 V      |
|          | Voltage range at any bus terminal (A, B, Y, Z)                                                  | –9 V to 14 V       |
|          | Voltage input, transient pulse through 100 $\Omega$ . See Figure 12 (A, B, Y, Z) <sup>(3)</sup> | –50 to 50 V        |
| $V_I$    | Voltage input range (D, DE, $\overline{RE}$ )                                                   | –0.5 V to 7 V      |
|          | Continuous total power dissipation                                                              | Internally limited |
| $I_O$    | Output current (receiver output only, R)                                                        | 11 mA              |

- (1) Stresses beyond those listed under absolute maximum ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under recommended operating conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
- (2) All voltage values, except differential I/O bus voltages, are with respect to network ground terminal.
- (3) This tests survivability only and the output state of the receiver is not specified.

## RECOMMENDED OPERATING CONDITIONS

over operating free-air temperature range (unless otherwise noted)

| PARAMETER            |                                                         | MIN                                        | NOM | MAX      | UNIT               |
|----------------------|---------------------------------------------------------|--------------------------------------------|-----|----------|--------------------|
| $V_{CC}$             | Supply voltage                                          | 4.5                                        |     | 5.5      | V                  |
| $V_I$ or $V_{IC}$    | Voltage at any bus terminal (separately or common mode) | –7 <sup>(1)</sup>                          |     | 12       | V                  |
| $1/t_{UI}$           | Signaling rate                                          | SN65HVD50, SN65HVD53, SN65HVD56, SN65HVD58 |     | 25       | Mbps               |
|                      |                                                         | SN65HVD51, SN65HVD54, SN65HVD57, SN65HVD59 |     | 5        |                    |
|                      |                                                         | SN65HVD52, SN65HVD55                       |     | 1        |                    |
| $R_L$                | Differential load resistance                            | 54                                         | 60  |          | $\Omega$           |
| $V_{IH}$             | High-level input voltage                                | D, DE, $\overline{RE}$                     | 2   | $V_{CC}$ | V                  |
| $V_{IL}$             | Low-level input voltage                                 | D, DE, $\overline{RE}$                     | 0   | 0.8      |                    |
| $V_{ID}$             | Differential input voltage                              |                                            | –12 | 12       |                    |
| $I_{OH}$             | High-level output current                               | Driver                                     | –60 |          | mA                 |
|                      |                                                         | Receiver                                   | –8  |          |                    |
| $I_{OL}$             | Low-level output current                                | Driver                                     |     | 60       | mA                 |
|                      |                                                         | Receiver                                   |     | 8        |                    |
| $T_J$ <sup>(2)</sup> | Junction temperature                                    | –40                                        |     | 150      | $^{\circ}\text{C}$ |

- (1) The algebraic convention, in which the least positive (most negative) limit is designated as minimum is used in this data sheet.
- (2) See thermal characteristics table for information regarding this specification.

## ELECTROSTATIC DISCHARGE PROTECTION

| PARAMETER                           | TEST CONDITIONS       | MIN | TYP <sup>(1)</sup> | MAX | UNIT |
|-------------------------------------|-----------------------|-----|--------------------|-----|------|
| Human body model                    | Bus terminals and GND |     | $\pm 16$           |     | kV   |
| Human body model <sup>(2)</sup>     | All pins              |     | $\pm 4$            |     |      |
| Charged-device-model <sup>(3)</sup> | All pins              |     | $\pm 1$            |     |      |

- (1) All typical values at 25 $^{\circ}\text{C}$  and with a 5-V supply.
- (2) Tested in accordance with JEDEC Standard 22, Test Method A114-A.
- (3) Tested in accordance with JEDEC Standard 22, Test Method C101.

## DRIVER ELECTRICAL CHARACTERISTICS

over recommended operating conditions unless otherwise noted

| PARAMETER                              |                                                                                |                                         | TEST CONDITIONS                                                                                                            |                                                                                    | MIN                       | TYP <sup>(1)</sup> | MAX             | UNIT |
|----------------------------------------|--------------------------------------------------------------------------------|-----------------------------------------|----------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------|---------------------------|--------------------|-----------------|------|
| V <sub>I(K)</sub>                      | Input clamp voltage                                                            |                                         | I <sub>I</sub> = −18 mA                                                                                                    |                                                                                    | −1.5                      |                    |                 |      |
| V <sub>OD(SS)</sub>                    | Steady-state differential output voltage                                       |                                         | I <sub>O</sub> = 0                                                                                                         |                                                                                    | 4                         |                    | V <sub>CC</sub> | V    |
|                                        |                                                                                |                                         | R <sub>L</sub> = 54 Ω, See <a href="#">Figure 1</a> (RS-485)                                                               |                                                                                    | 1.7                       | 2.6                |                 |      |
|                                        |                                                                                |                                         | R <sub>L</sub> = 100 Ω, See <a href="#">Figure 1</a> (RS-422)                                                              |                                                                                    | 2.4                       | 3.2                |                 |      |
|                                        |                                                                                |                                         | V <sub>test</sub> = −7 V to 12 V, See <a href="#">Figure 2</a>                                                             |                                                                                    | 1.6                       |                    |                 |      |
| Δ V <sub>OD(SS)</sub>                  | Change in magnitude of steady-state differential output voltage between states |                                         | R <sub>L</sub> = 54 Ω, See <a href="#">Figure 1</a> and <a href="#">Figure 2</a>                                           |                                                                                    | −0.2                      |                    | 0.2             |      |
| V <sub>OD(RING)</sub>                  | Differential Output Voltage overshoot and undershoot                           |                                         | R <sub>L</sub> = 54 Ω, C <sub>L</sub> = 50 pF, See <a href="#">Figure 5</a><br>See <a href="#">Figure 3</a> for definition |                                                                                    | 0.05  V <sub>OD(SS)</sub> |                    |                 |      |
| V <sub>OC(PP)</sub>                    | Peak-to-peak common-mode output voltage                                        | HVD50, HVD53, HVD56, HVD58              |                                                                                                                            | 0.5                                                                                |                           |                    |                 |      |
|                                        |                                                                                | HVD51, HVD54, HVD57, HVD59              |                                                                                                                            | 0.4                                                                                |                           |                    |                 |      |
|                                        |                                                                                | HVD52, HVD55                            |                                                                                                                            | 0.4                                                                                |                           |                    |                 |      |
| V <sub>OC(SS)</sub>                    | Steady-state common-mode output voltage                                        |                                         | See <a href="#">Figure 4</a>                                                                                               |                                                                                    | 2.2                       |                    | 3.3             |      |
| ΔV <sub>OC(SS)</sub>                   | Change in steady-state common-mode output voltage                              |                                         |                                                                                                                            |                                                                                    | −0.1                      |                    | 0.1             |      |
| I <sub>Z(Z)</sub> or I <sub>Y(Z)</sub> | High-impedance state output current                                            |                                         |                                                                                                                            | V <sub>CC</sub> = 0 V, V <sub>Z</sub> or V <sub>Y</sub> = 12 V, Other input at 0 V |                           | 90                 |                 | μA   |
|                                        |                                                                                |                                         |                                                                                                                            | V <sub>CC</sub> = 0 V, V <sub>Z</sub> or V <sub>Y</sub> = −7 V, Other input at 0 V |                           | −10                |                 |      |
|                                        |                                                                                | HVD53, HVD54, HVD55, HVD58, HVD59       | V <sub>CC</sub> = 5 V or 0 V, DE = 0 V<br>V <sub>Z</sub> or V <sub>Y</sub> = 12 V                                          | Other input at 0 V                                                                 | 90                        |                    |                 |      |
|                                        |                                                                                |                                         | V <sub>CC</sub> = 5 V or 0 V, DE = 0 V<br>V <sub>Z</sub> or V <sub>Y</sub> = −7 V                                          |                                                                                    | −10                       |                    |                 |      |
| I <sub>Z(S)</sub> or I <sub>Y(S)</sub> | Short Circuit output Current                                                   | V <sub>Z</sub> or V <sub>Y</sub> = −7 V |                                                                                                                            | Other input at 0 V                                                                 | −250                      |                    | 250             | mA   |
|                                        |                                                                                | V <sub>Z</sub> or V <sub>Y</sub> = 12 V |                                                                                                                            |                                                                                    | −250                      |                    | 250             |      |
| I <sub>I</sub>                         | Input current                                                                  | D, DE                                   |                                                                                                                            |                                                                                    | 0                         |                    | 100             | μA   |
| C <sub>(OD)</sub>                      | Differential output capacitance                                                |                                         | V <sub>OD</sub> = 0.4 sin (4E6πt) + 0.5 V, DE at 0 V                                                                       |                                                                                    | 16                        |                    |                 | pF   |

(1) All typical values are at 25°C and with a 5-V supply.

## DRIVER SWITCHING CHARACTERISTICS

over recommended operating conditions unless otherwise noted

| PARAMETER          |                                                             |                            | TEST CONDITIONS                                                                                                                                     | MIN | TYP <sup>(1)</sup> | MAX  | UNIT |
|--------------------|-------------------------------------------------------------|----------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------|-----|--------------------|------|------|
| $t_{PLH}$          | Propagation delay time, low-to-high-level output            | HVD50, HVD53, HVD56, HVD58 | $R_L = 54\ \Omega$ , $C_L = 50\ \text{pF}$ ,<br>See <a href="#">Figure 5</a>                                                                        | 4   | 8                  | 12   | ns   |
|                    |                                                             | HVD51, HVD54, HVD57, HVD59 |                                                                                                                                                     | 20  | 29                 | 46   |      |
|                    |                                                             | HVD52, HVD55               |                                                                                                                                                     | 90  | 143                | 230  |      |
| $t_{PHL}$          | Propagation delay time, high-to-low-level output            | HVD50, HVD53, HVD56, HVD58 |                                                                                                                                                     | 4   | 8                  | 12   | ns   |
|                    |                                                             | HVD51, HVD54, HVD57, HVD59 |                                                                                                                                                     | 20  | 30                 | 46   |      |
|                    |                                                             | HVD52, HVD55               |                                                                                                                                                     | 90  | 143                | 230  |      |
| $t_r$              | Differential output signal rise time                        | HVD50, HVD53, HVD56, HVD58 |                                                                                                                                                     | 3   | 6                  | 12   | ns   |
|                    |                                                             | HVD51, HVD54, HVD57, HVD59 |                                                                                                                                                     | 25  | 34                 | 60   |      |
|                    |                                                             | HVD52, HVD55               |                                                                                                                                                     | 130 | 197                | 300  |      |
| $t_f$              | Differential output signal fall time                        | HVD50, HVD53, HVD56, HVD58 |                                                                                                                                                     | 3   | 6                  | 11   | ns   |
|                    |                                                             | HVD51, HVD54, HVD57, HVD59 |                                                                                                                                                     | 25  | 33                 | 60   |      |
|                    |                                                             | HVD52, HVD55               |                                                                                                                                                     | 130 | 192                | 300  |      |
| $t_{sk(p)}$        | Pulse skew ( $ t_{PHL} - t_{PLH} $ )                        | HVD50, HVD53, HVD56, HVD58 |                                                                                                                                                     |     |                    | 2    | ns   |
|                    |                                                             | HVD51, HVD54, HVD57, HVD59 |                                                                                                                                                     |     |                    | 2    |      |
|                    |                                                             | HVD52, HVD55               |                                                                                                                                                     |     |                    | 8    |      |
| $t_{sk(pp)}^{(2)}$ | Part-to-part skew                                           | HVD50, HVD53, HVD56, HVD58 |                                                                                                                                                     |     | 1                  |      | ns   |
|                    |                                                             | HVD51, HVD54, HVD57, HVD59 |                                                                                                                                                     |     | 4                  |      |      |
|                    |                                                             | HVD52, HVD55               |                                                                                                                                                     |     | 22                 |      |      |
| $t_{PZH1}$         | Propagation delay time, high-impedance-to-high-level output | HVD53, HVD58               | $R_L = 110\ \Omega$ , $\overline{RE}$ at 0 V,<br>See <a href="#">Figure 6</a><br>$D = 3\ \text{V}$ and $S1 = Y$ ,<br>$D = 0\ \text{V}$ and $S1 = Z$ |     |                    | 30   | ns   |
|                    |                                                             | HVD54, HVD59               |                                                                                                                                                     |     |                    | 180  |      |
|                    |                                                             | HVD55                      |                                                                                                                                                     |     |                    | 380  |      |
| $t_{PHZ}$          | Propagation delay time, high-level-to-high-impedance output | HVD53, HVD58               |                                                                                                                                                     |     |                    | 16   | ns   |
|                    |                                                             | HVD54, HVD59               |                                                                                                                                                     |     |                    | 40   |      |
|                    |                                                             | HVD55                      |                                                                                                                                                     |     |                    | 110  |      |
| $t_{PZL1}$         | Propagation delay time, high-impedance-to-low-level output  | HVD53, HVD58               | $R_L = 110\ \Omega$ , $\overline{RE}$ at 0 V,<br>See <a href="#">Figure 7</a><br>$D = 3\ \text{V}$ and $S1 = Z$ ,<br>$D = 0\ \text{V}$ and $S1 = Y$ |     |                    | 23   | ns   |
|                    |                                                             | HVD54, HVD59               |                                                                                                                                                     |     |                    | 200  |      |
|                    |                                                             | HVD55                      |                                                                                                                                                     |     |                    | 420  |      |
| $t_{PLZ}$          | Propagation delay time, low-level-to-high-impedance output  | HVD53, HVD58               |                                                                                                                                                     |     |                    | 19   | ns   |
|                    |                                                             | HVD54, HVD59               |                                                                                                                                                     |     |                    | 70   |      |
|                    |                                                             | HVD55                      |                                                                                                                                                     |     |                    | 160  |      |
| $t_{PZH2}$         | Propagation delay time, standby-to-high-level output        |                            | $R_L = 110\ \Omega$ , $\overline{RE}$ at 3 V,<br>See <a href="#">Figure 6</a><br>$D = 3\ \text{V}$ and $S1 = Y$ ,<br>$D = 0\ \text{V}$ and $S1 = Z$ |     |                    | 3300 | ns   |
| $t_{PZL2}$         | Propagation delay time, standby-to-low-level output         |                            | $R_L = 110\ \Omega$ , $\overline{RE}$ at 3 V,<br>See <a href="#">Figure 7</a><br>$D = 3\ \text{V}$ and $S1 = Z$ ,<br>$D = 0\ \text{V}$ and $S1 = Y$ |     |                    | 3300 | ns   |

(1) All typical values are at 25°C and with a 5-V supply.

(2)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

## RECEIVER ELECTRICAL CHARACTERISTICS

over recommended operating conditions unless otherwise noted

| PARAMETER      |                                                         | TEST CONDITIONS                                                                                                          | MIN                   | TYP <sup>(1)</sup> | MAX   | UNIT          |
|----------------|---------------------------------------------------------|--------------------------------------------------------------------------------------------------------------------------|-----------------------|--------------------|-------|---------------|
| $V_{IT+}$      | Positive-going differential input threshold voltage     | $I_O = -8 \text{ mA}$                                                                                                    |                       |                    | -0.02 | V             |
| $V_{IT-}$      | Negative-going differential input threshold voltage     | $I_O = 8 \text{ mA}$                                                                                                     | -0.20                 |                    |       |               |
| $V_{hys}$      | Hysteresis voltage ( $V_{IT+} - V_{IT-}$ )              |                                                                                                                          |                       | 50                 |       | mV            |
| $V_{IK}$       | Enable-input clamp voltage                              | $I_I = -18 \text{ mA}$                                                                                                   | -1.5                  |                    |       | V             |
| $V_O$          | Output voltage                                          | $V_{ID} = 200 \text{ mV}$ , $I_O = -8 \text{ mA}$ , See <a href="#">Figure 8</a>                                         | 4.0                   |                    |       | V             |
|                |                                                         | $V_{ID} = -200 \text{ mV}$ , $I_O = 8 \text{ mA}$ , See <a href="#">Figure 8</a>                                         |                       |                    | 0.3   |               |
| $I_{O(Z)}$     | High-impedance-state output current                     | $V_O = 0$ or $V_{CC}\overline{RE}$ at $V_{CC}$                                                                           | -1                    |                    | 1     | $\mu\text{A}$ |
| $I_A$ or $I_B$ | HVD50,<br>HVD53,<br>HVD56,<br>HVD58                     | $V_A$ or $V_B = 12 \text{ V}$                                                                                            | Other input<br>at 0 V | 0.19               | 0.3   | mA            |
|                |                                                         | $V_A$ or $V_B = 12 \text{ V}$ , $V_{CC} = 0 \text{ V}$                                                                   |                       | 0.24               | 0.4   |               |
|                |                                                         | $V_A$ or $V_B = -7 \text{ V}$                                                                                            |                       | -0.35              | -0.19 |               |
|                |                                                         | $V_A$ or $V_B = -7 \text{ V}$ , $V_{CC} = 0 \text{ V}$                                                                   |                       | -0.25              | -0.14 |               |
|                | HVD51,<br>HVD52,<br>HVD54,<br>HVD55,<br>HVD57,<br>HVD59 | $V_A$ or $V_B = 12 \text{ V}$                                                                                            | Other input<br>at 0 V | 0.05               | 0.10  | mA            |
|                |                                                         | $V_A$ or $V_B = 12 \text{ V}$ , $V_{CC} = 0 \text{ V}$                                                                   |                       | 0.06               | 0.10  |               |
|                |                                                         | $V_A$ or $V_B = -7 \text{ V}$                                                                                            |                       | -0.10              | -0.05 |               |
|                |                                                         | $V_A$ or $V_B = -7 \text{ V}$ , $V_{CC} = 0 \text{ V}$                                                                   |                       | -0.10              | -0.03 |               |
| $I_{IH}$       | Input current, $\overline{RE}$                          | $V_{IH} = 2 \text{ V}$                                                                                                   | -60                   |                    |       | $\mu\text{A}$ |
|                |                                                         | $V_{IL} = 0.8 \text{ V}$                                                                                                 | -60                   |                    |       | $\mu\text{A}$ |
| $C_{ID}$       | Differential input capacitance                          | $V_{ID} = 0.4 \sin(4E6\pi t) + 0.5 \text{ V}$ , DE at 0 V                                                                |                       | 16                 |       | pF            |
| $I_{CC}$       | HVD50,<br>HVD51,<br>HVD52                               | D at 0 V or $V_{CC}$ and No Load                                                                                         |                       |                    | 8.0   | mA            |
|                |                                                         |                                                                                                                          |                       |                    | 9.5   |               |
|                |                                                         |                                                                                                                          |                       |                    | 2.3   |               |
|                |                                                         |                                                                                                                          |                       |                    | 2.9   |               |
|                |                                                         |                                                                                                                          |                       |                    | 4.5   |               |
|                | HVD53,<br>HVD54,<br>HVD55,<br>HVD58,<br>HVD59           | $\overline{RE}$ at $V_{CC}$ , D at $V_{CC}$ , DE at 0 V,<br>No load (Receiver disabled and<br>driver disabled)           |                       | 0.08               | 1     | $\mu\text{A}$ |
|                |                                                         |                                                                                                                          |                       |                    |       |               |
|                |                                                         |                                                                                                                          |                       |                    |       |               |
|                |                                                         |                                                                                                                          |                       |                    |       |               |
|                |                                                         |                                                                                                                          |                       |                    |       |               |
|                | HVD53,<br>HVD54,<br>HVD55,<br>HVD58,<br>HVD59           | $\overline{RE}$ at 0 V, D at 0 V or $V_{CC}$ , DE at $V_{CC}$ ,<br>No load (Receiver enabled and<br>driver enabled)      |                       |                    | 2.7   | mA            |
|                |                                                         |                                                                                                                          |                       |                    | 8.0   |               |
|                |                                                         |                                                                                                                          |                       |                    | 4.3   |               |
|                |                                                         |                                                                                                                          |                       |                    | 9.7   |               |
|                |                                                         |                                                                                                                          |                       |                    | 2.3   |               |
|                | HVD53,<br>HVD54,<br>HVD55,<br>HVD58,<br>HVD59           | $\overline{RE}$ at $V_{CC}$ , D at 0 V or $V_{CC}$ , DE at $V_{CC}$<br>No load (Receiver disabled and<br>driver enabled) |                       |                    | 7.7   | mA            |
|                |                                                         |                                                                                                                          |                       |                    | 3.2   |               |
|                |                                                         |                                                                                                                          |                       |                    | 8.5   |               |

(1) All typical values are at 25°C and with a 5-V supply.

## RECEIVER SWITCHING CHARACTERISTICS

over recommended operating conditions unless otherwise noted

| PARAMETER          |                                                      | TEST CONDITIONS                                                  | MIN                                                                                                | TYP <sup>(1)</sup> | MAX  | UNIT |
|--------------------|------------------------------------------------------|------------------------------------------------------------------|----------------------------------------------------------------------------------------------------|--------------------|------|------|
| $t_{PLH}$          | Propagation delay time, low-to-high-level output     | HVD50, HVD53, HVD56, HVD58                                       |                                                                                                    | 24                 | 40   | ns   |
|                    |                                                      | HVD51, HVD52, HVD54, HVD55, HVD57, HVD59                         |                                                                                                    | 43                 | 55   |      |
| $t_{PHL}$          | Propagation delay time, high-to-low-level output     | HVD50, HVD53, HVD56, HVD58                                       |                                                                                                    | 26                 | 35   |      |
|                    |                                                      | HVD51, HVD52, HVD54, HVD55, HVD57, HVD59                         |                                                                                                    | 47                 | 60   |      |
| $t_{sk(p)}$        | Pulse skew ( $ t_{PHL} - t_{PLH} $ )                 | HVD50, HVD53, HVD56, HVD57, HVD58, HVD59                         | $V_{ID} = -1.5\text{ V to }1.5\text{ V},$<br>$C_L = 15\text{ pF},$<br>See <a href="#">Figure 9</a> |                    | 5    |      |
|                    |                                                      | HVD51, HVD54, HVD52, HVD55                                       |                                                                                                    |                    | 7    |      |
| $t_{sk(pp)}^{(2)}$ | Part-to-part skew                                    | HVD50, HVD53, HVD56, HVD58                                       |                                                                                                    |                    | 5    |      |
|                    |                                                      | HVD51, HVD54, HVD57, HVD59                                       |                                                                                                    |                    | 6    |      |
|                    |                                                      | HVD52, HVD55                                                     |                                                                                                    |                    | 6    |      |
| $t_r$              | Output signal rise time                              |                                                                  |                                                                                                    | 2.3                | 4    |      |
| $t_f$              | Output signal fall time                              |                                                                  |                                                                                                    | 2.4                | 4    |      |
| $t_{PHZ}$          | Output disable time from high level                  | DE at 3 V, $C_L = 15\text{ pF}$<br>See <a href="#">Figure 10</a> |                                                                                                    |                    | 17   |      |
| $t_{PZH1}$         | Output enable time to high level                     |                                                                  |                                                                                                    |                    | 10   |      |
| $t_{PZH2}$         | Propagation delay time, standby-to-high-level output | DE at 0 V, $C_L = 15\text{ pF}$<br>See <a href="#">Figure 10</a> |                                                                                                    |                    | 3300 |      |
| $t_{PLZ}$          | Output disable time from low level                   | DE at 3 V, $C_L = 15\text{ pF}$<br>See <a href="#">Figure 11</a> |                                                                                                    |                    | 13   |      |
| $t_{PZL1}$         | Output enable time to low level                      |                                                                  |                                                                                                    |                    | 10   |      |
| $t_{PZL2}$         | Propagation delay time, standby-to-low-level output  | DE at 0 V, $C_L = 15\text{ pF}$<br>See <a href="#">Figure 11</a> |                                                                                                    |                    | 3300 |      |

(1) All typical values are at 25°C and with a 5-V supply

(2)  $t_{sk(pp)}$  is the magnitude of the difference in propagation delay times between any specified terminals of two devices when both devices operate with the same supply voltages, at the same temperature, and have identical packages and test circuits.

## RECEIVER EQUALIZATION CHARACTERISTICS

over recommended operating conditions unless otherwise noted<sup>(1)</sup>

| PARAMETER          |                                 | TEST CONDITIONS                                                              |              |        |              | MIN     | TYP <sup>(2)</sup> | MAX | UNIT |
|--------------------|---------------------------------|------------------------------------------------------------------------------|--------------|--------|--------------|---------|--------------------|-----|------|
| t <sub>j(pp)</sub> | Peak-to-peak eye-pattern jitter | Pseudo-random NRZ code with a bit pattern length o 216-1, Belden 3105A cable | 25 Mbps      | 0 m    | HVD56, HVD58 | PREVIEW |                    | ns  |      |
|                    |                                 |                                                                              |              | 100 m  | HVD53        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD56, HVD58 | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              | 150 m  | HVD53        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD56, HVD58 | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              | 200 m  | HVD53        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              | HVD56, HVD58 |        | PREVIEW      |         |                    |     |      |
|                    |                                 |                                                                              | 10 Mbps      | 200 m  | HVD53        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD56, HVD58 | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              | 250 m  | HVD53        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD56, HVD58 | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              | 300 m  | HVD53        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD56, HVD58 | PREVIEW |                    |     |      |
|                    |                                 |                                                                              | 5 Mbps       | 500 m  | HVD54        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD57, HVD59 | PREVIEW |                    |     |      |
|                    |                                 |                                                                              | 3 Mbps       | 500 m  | HVD53        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD54        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD56, HVD58 | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD57, HVD59 | PREVIEW |                    |     |      |
|                    |                                 |                                                                              | 1 Mbps       | 1000 m | HVD54        | PREVIEW |                    |     |      |
|                    |                                 |                                                                              |              |        | HVD57, HVD59 | PREVIEW |                    |     |      |

(1) The HVD53 and HVD54 do not have receiver equalization but are specified for comparison.

(2) All typical values are at  $V_{CC} = 5\text{ V}$ , and temperature = 25°C.



## THERMAL CHARACTERISTICS

over operating free-air temperature range unless otherwise noted<sup>(1)</sup>

| PARAMETER     | TEST CONDITIONS                                       |                                                                                                                                 | MIN                               | TYP | MAX   | UNIT |
|---------------|-------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------|-----------------------------------|-----|-------|------|
| $\theta_{JA}$ | Junction-to-ambient thermal resistance <sup>(2)</sup> | Low-K board <sup>(3)</sup> , No airflow                                                                                         | HVD50, HVD51, HVD52, HVD56, HVD57 |     | 230.8 | °C/W |
|               |                                                       |                                                                                                                                 | HVD53, HVD54, HVD55, HVD58, HVD59 |     | 162.6 |      |
|               | Junction-to-ambient thermal resistance <sup>(2)</sup> | High-K board <sup>(4)</sup> , No airflow                                                                                        | HVD50, HVD51, HVD52, HVD56, HVD57 |     | 135.1 |      |
|               |                                                       |                                                                                                                                 | HVD53, HVD54, HVD55, HVD58, HVD59 |     | 92.1  |      |
| $\theta_{JB}$ | Junction-to-board thermal resistance                  | High-K board                                                                                                                    | HVD50, HVD51, HVD52, HVD56, HVD57 |     | 44.4  |      |
|               |                                                       |                                                                                                                                 | HVD53, HVD54, HVD55, HVD58, HVD59 |     | 61.1  |      |
| $\theta_{JC}$ | Junction-to-case thermal resistance                   | No board                                                                                                                        | HVD50, HVD51, HVD52, HVD56, HVD57 |     | 43.5  |      |
|               |                                                       |                                                                                                                                 | HVD53, HVD54, HVD55, HVD58, HVD59 |     | 58.6  |      |
| $P_D$         | Device power dissipation                              | $R_L = 60\Omega$ , $C_L = 50$ pF, Input to D a 50% duty cycle square wave at indicated signaling rate                           | HVD50, HVD56 (25Mbps)             |     | 420   | mW   |
|               |                                                       |                                                                                                                                 | HVD51, HVD57 (10Mbps)             |     | 404   |      |
|               |                                                       |                                                                                                                                 | HVD52 (1Mbps)                     |     | 383   |      |
|               |                                                       | $R_L = 60\Omega$ , $C_L = 50$ pF, DE at $V_{CC}$ RE at 0 V, Input to D a 50% duty cycle square wave at indicated signaling rate | HVD53, HVD58 (25Mbps)             |     | 420   |      |
|               |                                                       |                                                                                                                                 | HVD54, HVD59 (10Mbps)             |     | 404   |      |
|               |                                                       |                                                                                                                                 | HVD55 (1Mbps)                     |     | 383   |      |
| $T_A$         | Ambient air temperature                               | Low-K board, No airflow                                                                                                         | HVD50, HVD56                      |     | –40   | °C   |
|               |                                                       |                                                                                                                                 | HVD51, HVD52, HVD57               |     | –40   |      |
|               |                                                       |                                                                                                                                 | HVD53, HVD54, HVD55, HVD58, HVD59 |     | –40   |      |
|               |                                                       | High-K board, No airflow                                                                                                        | HVD50, HVD51, HVD52, HVD56, HVD57 |     | –40   |      |
|               |                                                       |                                                                                                                                 | HVD53, HVD54, HVD55, HVD58, HVD59 |     | –40   |      |
| $T_{JSD}$     | Thermal shutdown junction temperature                 |                                                                                                                                 |                                   |     | 165   |      |

(1) See *Application Information* section for an explanation of these parameters.

(2) The intent of  $\theta_{JA}$  specification is solely for a thermal performance comparison of one package to another in a standardized environment. This methodology is not meant to and will not predict the performance of a package in an application-specific environment.

(3) In accordance with the Low-K thermal metric definitions of EIA/JESD51-3.

(4) In accordance with the High-K thermal metric definitions of EIA/JESD51-7.

## PARAMETER MEASUREMENT INFORMATION

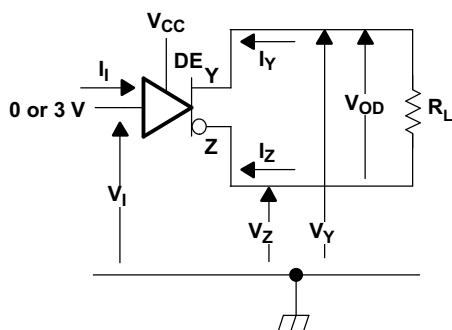


Figure 1. Driver  $V_{OD}$  Test Circuit: Voltage and Current Definitions

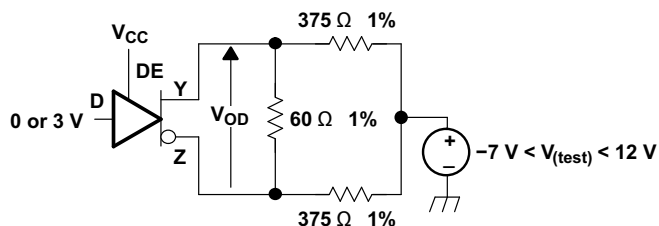
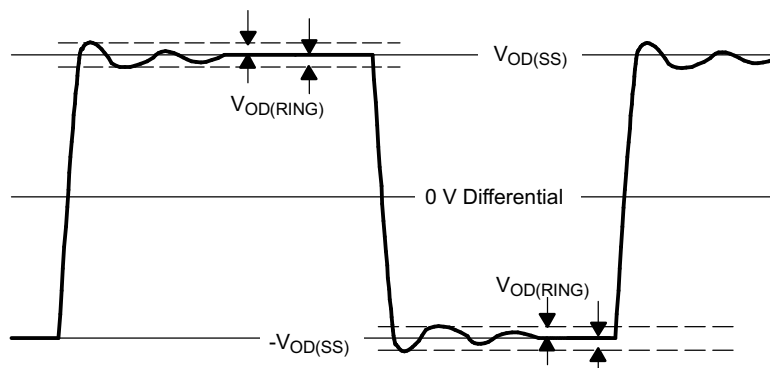


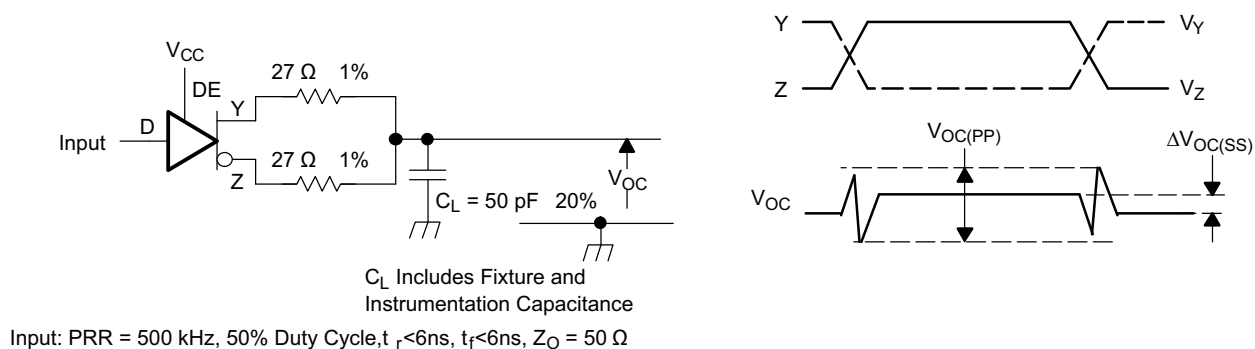
Figure 2. Driver  $V_{OD}$  With Common-Mode Loading Test Circuit

## PARAMETER MEASUREMENT INFORMATION (continued)

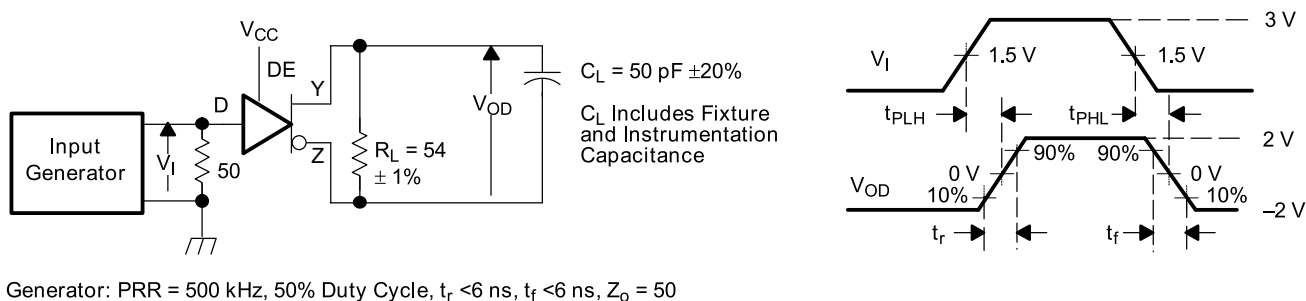
VOD(RING) is measured at four points on the output waveform, corresponding to overshoot and undershoot from the VOD(H) and VOD(L) steady state values.



**Figure 3. V<sub>OD(RING)</sub> Waveform and Definitions**



**Figure 4. Test Circuit and Definitions for the Driver Common-Mode Output Voltage**



**Figure 5. Driver Switching Test Circuit and Voltage Waveforms**

## PARAMETER MEASUREMENT INFORMATION (continued)

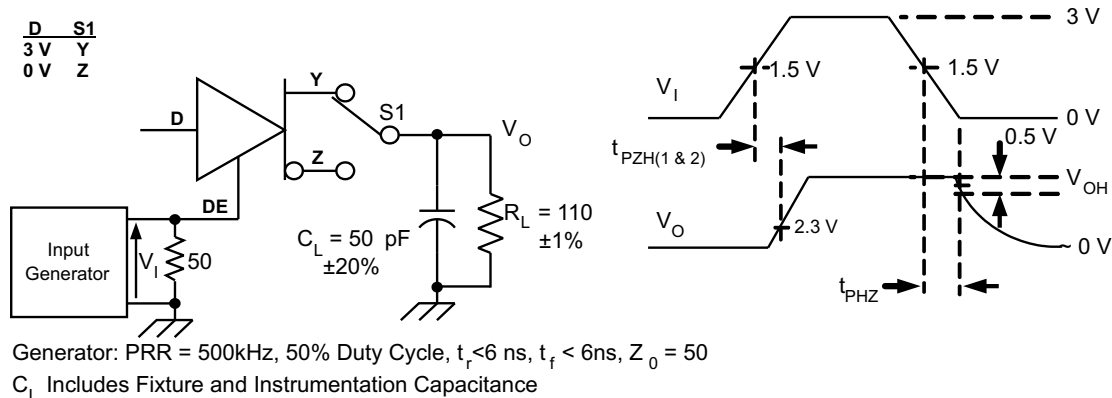


Figure 6. Driver High-Level Output Enable and Disable Time Test Circuit and Voltage Waveforms

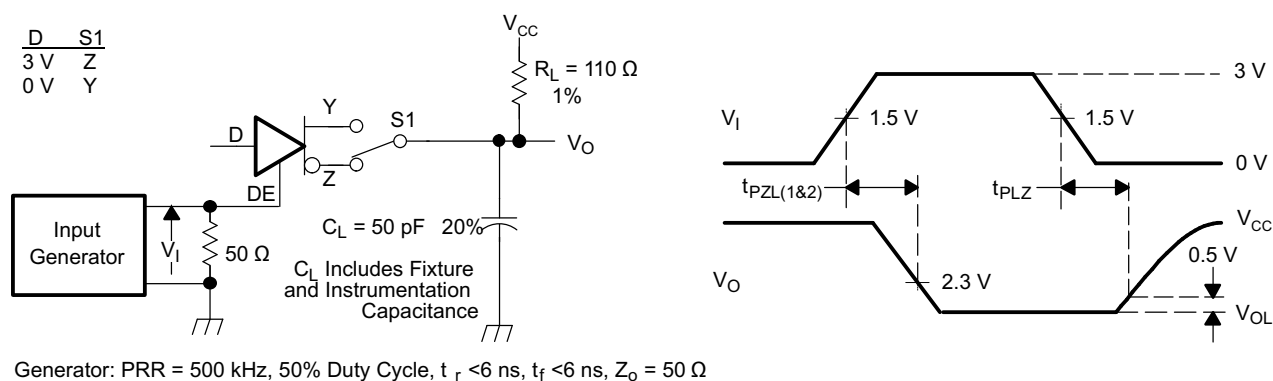


Figure 7. Driver Low-Level Output Enable and Disable Time Test Circuit and Voltage Waveforms

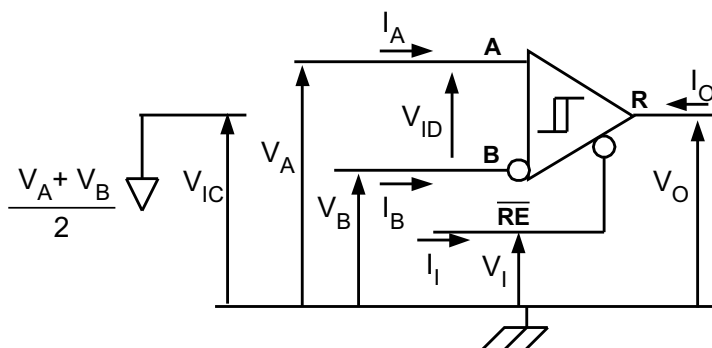
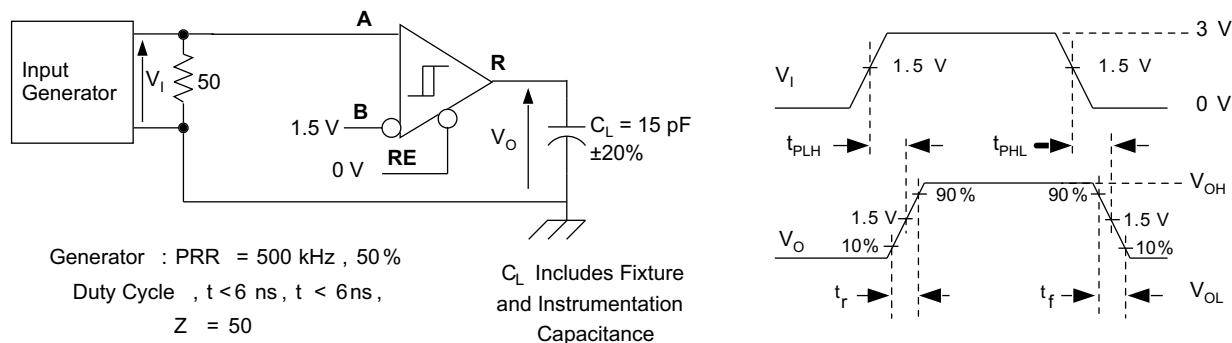
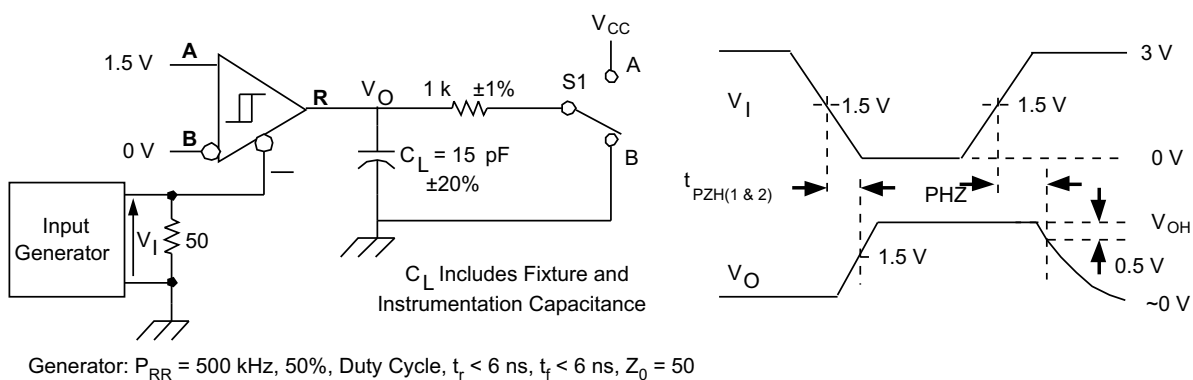


Figure 8. Receiver Voltage and Current Definitions

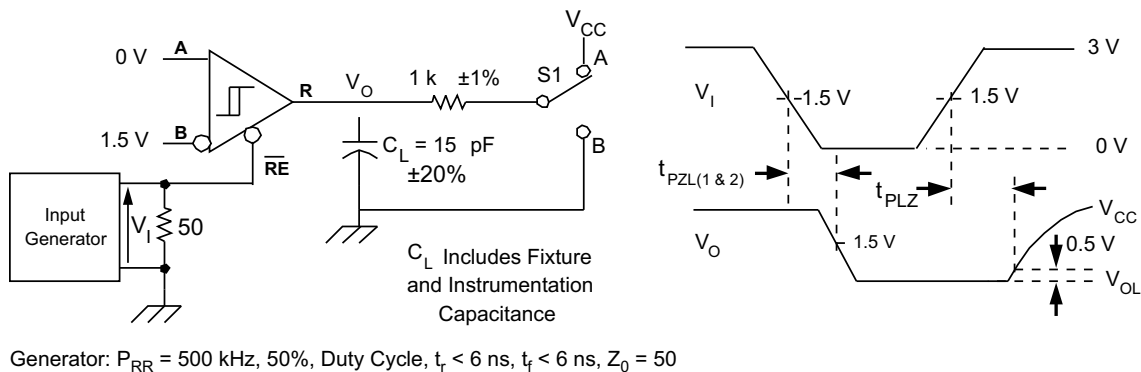
## PARAMETER MEASUREMENT INFORMATION (continued)



**Figure 9. Receiver Switching Test Circuit and Voltage Waveforms**



**Figure 10. Receiver High-Level Enable and Disable Time Test Circuit and Voltage Waveforms**



**Figure 11. Receiver Low-Level Enable and Disable Time Test Circuit and Voltage Waveforms**

## PARAMETER MEASUREMENT INFORMATION (continued)

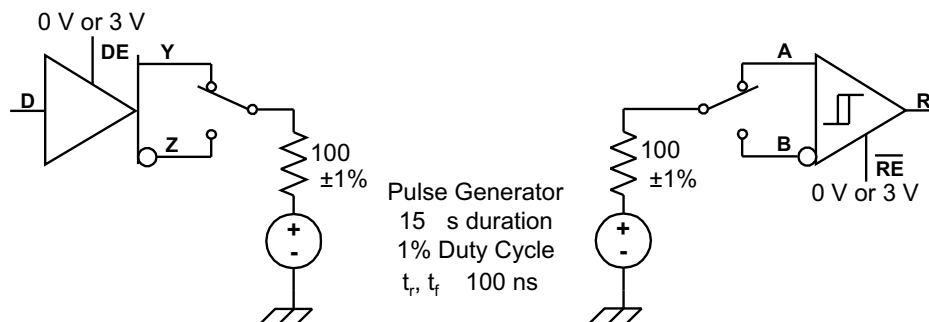


Figure 12. Test Circuit, Transient Overvoltage Test

## DEVICE INFORMATION

### LOW-POWER SHUTDOWN MODE

When both the driver and receiver are disabled ( $\overline{DE}$  low and  $\overline{RE}$  high) the device is in shutdown mode. If the enable inputs are in this state for less than 60 ns, the device does not enter shutdown mode. This guards against inadvertently entering shutdown mode during driver/receiver enabling. Only when the enable inputs are held in this state for 300 ns or more, the device is assured to be in shutdown mode. In this low-power shutdown mode, most internal circuitry is powered down, and the supply current is typically less than 1 nA. When either the driver or the receiver is re-enabled, the internal circuitry becomes active.

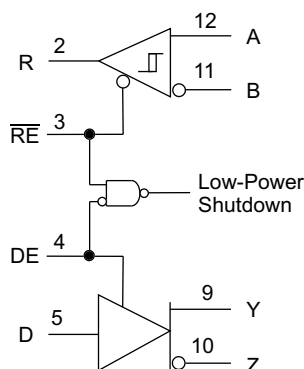


Figure 13. Low-Power Shutdown Logic Diagram

If only the driver is re-enabled ( $\overline{DE}$  transitions to high) the driver outputs are driven according to the D input after the enable times given by  $t_{PZH2}$  and  $t_{PZL2}$  in the driver switching characteristics. If the D input is open when the driver is enabled, the driver outputs default to A high and B low, in accordance with the driver failsafe feature.

If only the receiver is re-enabled ( $\overline{RE}$  transitions to low) the receiver output is driven according to the state of the bus inputs (A and B) after the enable times given by  $t_{PZH2}$  and  $t_{PZL2}$  in the receiver switching characteristics. If there is no valid state on the bus the receiver responds as described in the failsafe operation section.

If both the receiver and driver are re-enabled simultaneously, the receiver output is driven according to the state of the bus inputs (A and B) and the driver output is driven according to the D input. Note that the state of the active driver affects the inputs to the receiver. Therefore, the receiver outputs are valid as soon as the driver outputs are valid.

## DEVICE INFORMATION (continued)

### FUNCTION TABLES

#### SN65HVD53, SN65HVD54, SN65HVD55, SN65HVD58, SN65HVD59 DRIVER

| INPUTS |           | OUTPUTS |   |
|--------|-----------|---------|---|
| D      | DE        | Y       | Z |
| H      | H         | H       | L |
| L      | H         | L       | H |
| X      | L or open | Z       | Z |
| Open   | H         | L       | H |

#### SN65HVD53, SN65HVD54, SN65HVD55, SN65HVD58, SN65HVD59 RECEIVER

| DIFFERENTIAL INPUTS<br>$V_{ID} = V_A - V_B$ | ENABLE<br>RE | OUTPUT<br>R |
|---------------------------------------------|--------------|-------------|
| $V_{ID} \leq -0.2 \text{ V}$                | L            | L           |
| $-0.2 \text{ V} < V_{ID} < -0.02 \text{ V}$ | L            | ?           |
| $-0.02 \text{ V} \leq V_{ID}$               | L            | H           |
| X                                           | H or open    | Z           |
| Open Circuit                                | L            | H           |
| Idle circuit                                | L            | H           |
| Short Circuit, $V_A = V_B$                  | L            | H           |

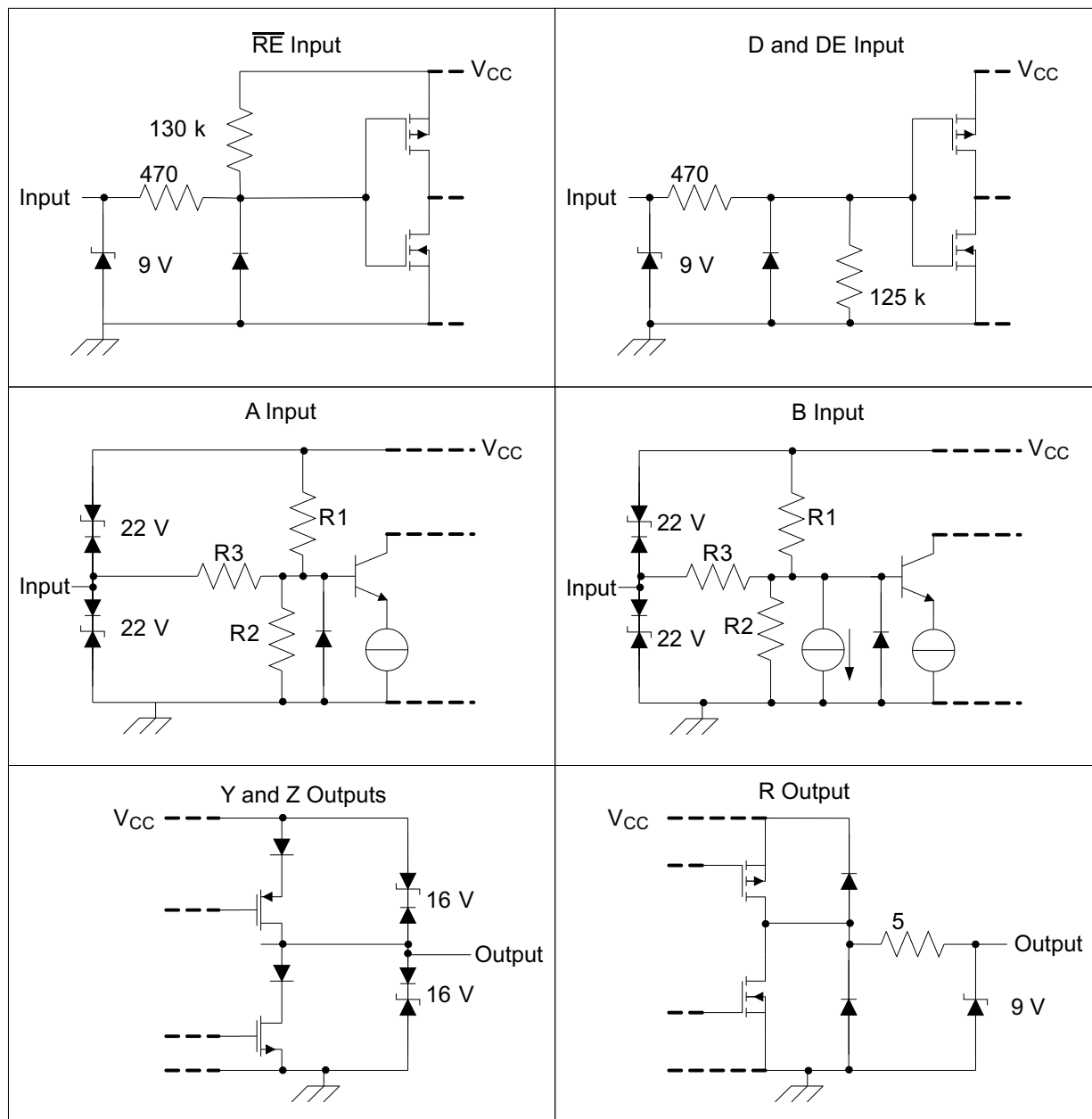
#### SN65HVD50, SN65HVD51, SN65HVD52, SN65HVD56, SN65HVD57 DRIVER

| INPUT<br>D | OUTPUTS |   |
|------------|---------|---|
|            | Y       | Z |
| H          | H       | L |
| L          | L       | H |
| Open       | L       | H |

#### SN65HVD50, SN65HVD51, SN65HVD52, SN65HVD56, SN65HVD57 RECEIVER

| DIFFERENTIAL INPUTS<br>$V_{ID} = V_A - V_B$ | OUTPUT<br>R |
|---------------------------------------------|-------------|
| $V_{ID} \leq -0.2 \text{ V}$                | L           |
| $-0.2 \text{ V} < V_{ID} < -0.02 \text{ V}$ | ?           |
| $-0.02 \text{ V} \leq V_{ID}$               | H           |
| Open Circuit                                | H           |
| Idle circuit                                | H           |
| Short Circuit, $V_A = V_B$                  | H           |

## EQUIVALENT INPUT AND OUTPUT SCHEMATIC DIAGRAMS



|                                                                             | R1/R2 | R3     |
|-----------------------------------------------------------------------------|-------|--------|
| SN65HVD50, SN65HVD53, SN65HVD56, SN65HVD58                                  | 9 kΩ  | 45 kΩ  |
| SN65HVD51, SN65HVD52, SN65HVD54, SN65HVD55, SN65HVD57, SN65HVD58, SN65HVD59 | 36 kΩ | 180 kΩ |

## TYPICAL CHARACTERISTICS

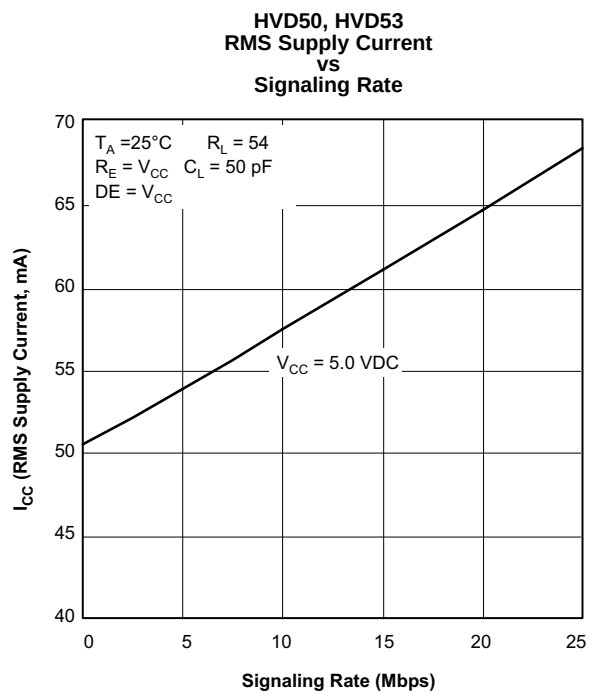


Figure 14.

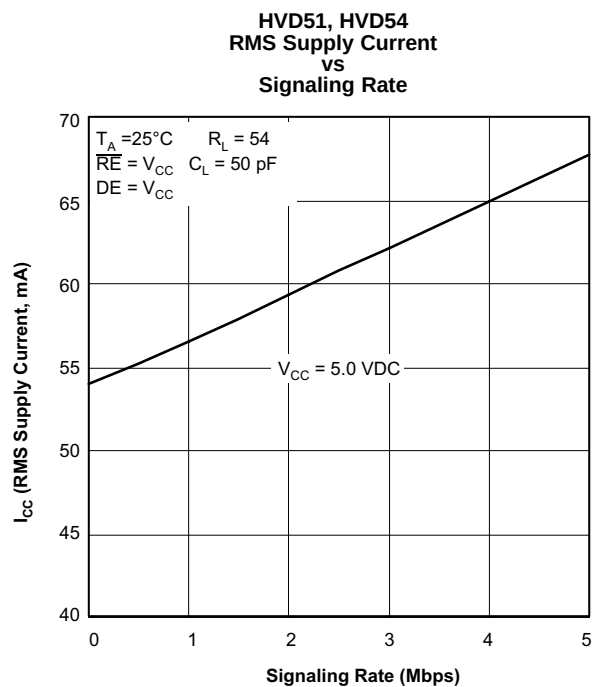


Figure 15.

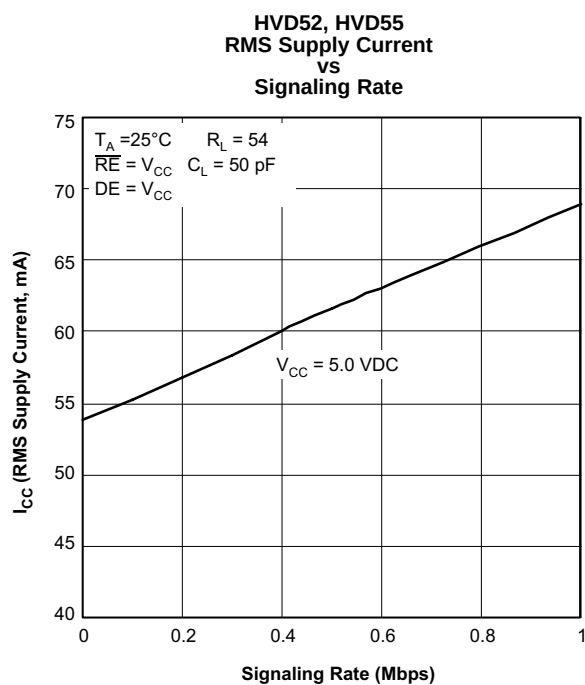


Figure 16.



## TYPICAL CHARACTERISTICS (continued)

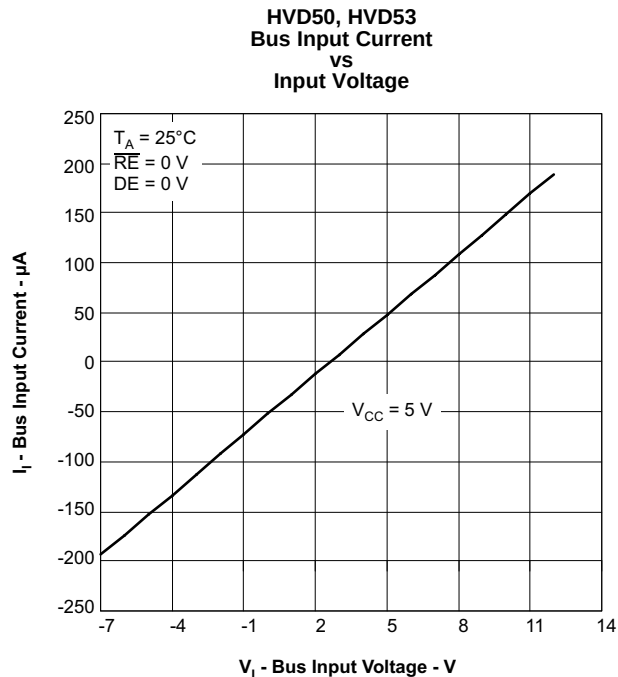


Figure 17.

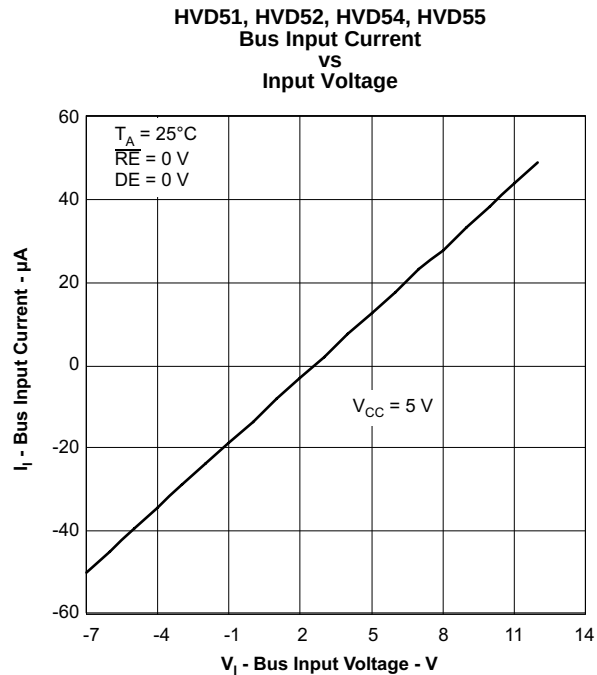


Figure 18.

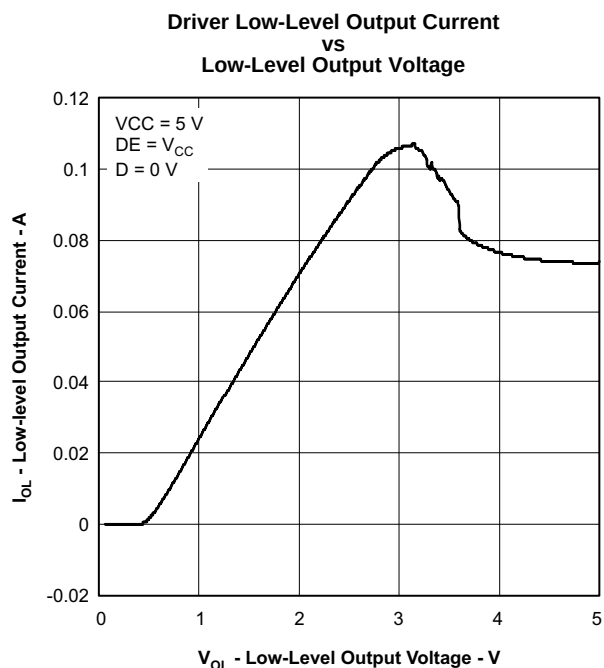


Figure 19.

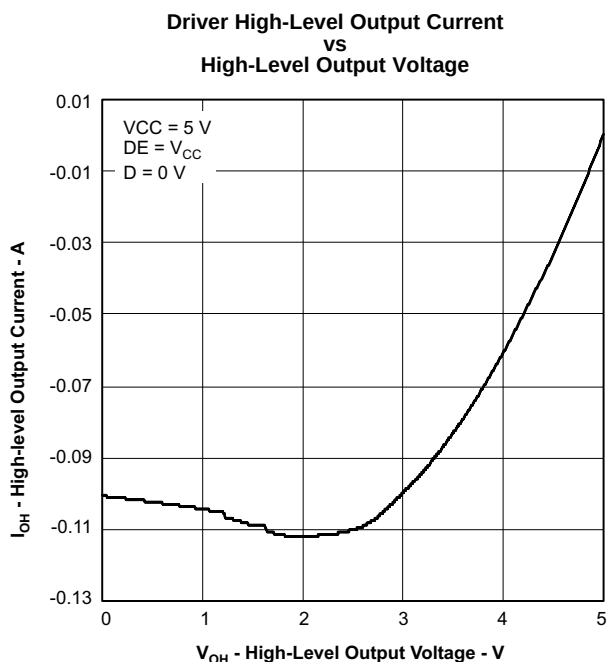


Figure 20.

## TYPICAL CHARACTERISTICS (continued)

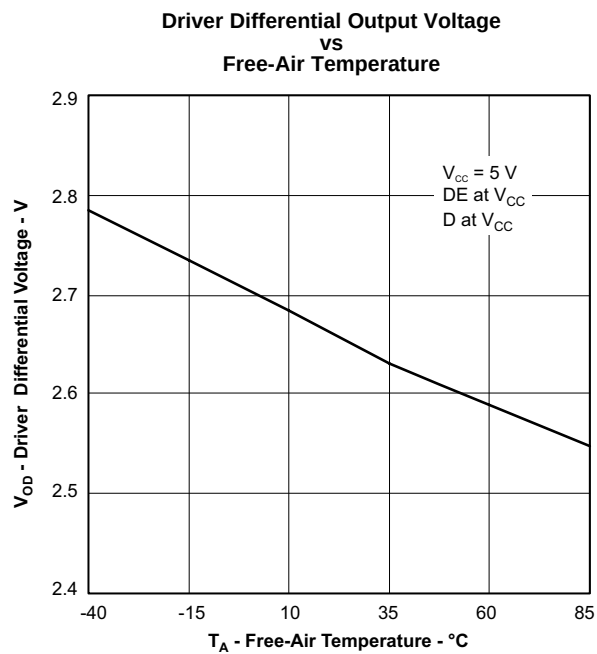


Figure 21.

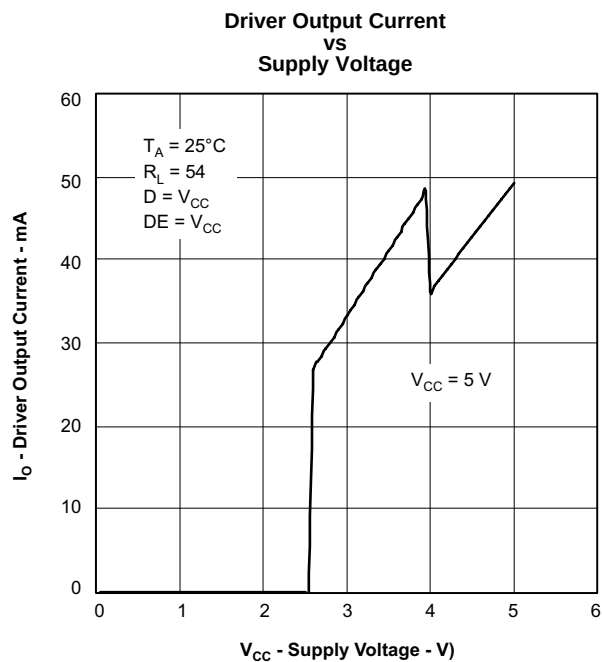


Figure 22.

## APPLICATION INFORMATION

### THERMAL CHARACTERISTICS OF IC PACKAGES

$\theta_{JA}$  (**Junction-to-Ambient Thermal Resistance**) is defined as the difference in junction temperature to ambient temperature divided by the operating power.

$\theta_{JA}$  is not a constant and is a strong function of:

- the PCB design (50% variation)
- altitude (20% variation)
- device power (5% variation)

$\theta_{JA}$  can be used to compare the thermal performance of packages if the specific test conditions are defined and used. Standardized testing includes specification of PCB construction, test chamber volume, sensor locations, and the thermal characteristics of holding fixtures.  $\theta_{JA}$  is often misused when it is used to calculate junction temperatures for other installations.

TI uses two test PCBs as defined by JEDEC specifications. The low-k board gives *average* in-use condition thermal performance, and it consists of a single copper trace layer 25 mm long and 2-oz thick. The high-k board gives best case in-use condition, and it consists of two 1-oz buried power planes with a single copper trace layer 25 mm long and 2-oz thick. A 4% to 50% difference in  $\theta_{JA}$  can be measured between these two test cards

$\theta_{JC}$  (**Junction-to-Case Thermal Resistance**) is defined as difference in junction temperature to case divided by the operating power. It is measured by putting the mounted package up against a copper block cold plate to force heat to flow from die, through the mold compound into the copper block.

$\theta_{JC}$  is a useful thermal characteristic when a heatsink applied to package. It is *not* a useful characteristic to predict junction temperature because it provides pessimistic numbers if the case temperature is measured in a nonstandard system and junction temperatures are backed out. It can be used with  $\theta_{JB}$  in 1-dimensional thermal simulation of a package system.

$\theta_{JB}$  (**Junction-to-Board Thermal Resistance**) is defined as the difference in the junction temperature and the PCB temperature at the center of the package (closest to the die) when the PCB is clamped in a cold-plate structure.  $\theta_{JB}$  is only defined for the high-k test card.

$\theta_{JB}$  provides an overall thermal resistance between the die and the PCB. It includes a bit of the PCB thermal resistance (especially for BGA's with thermal balls) and can be used for simple 1-dimensional network analysis of package system, see [Figure 23](#).

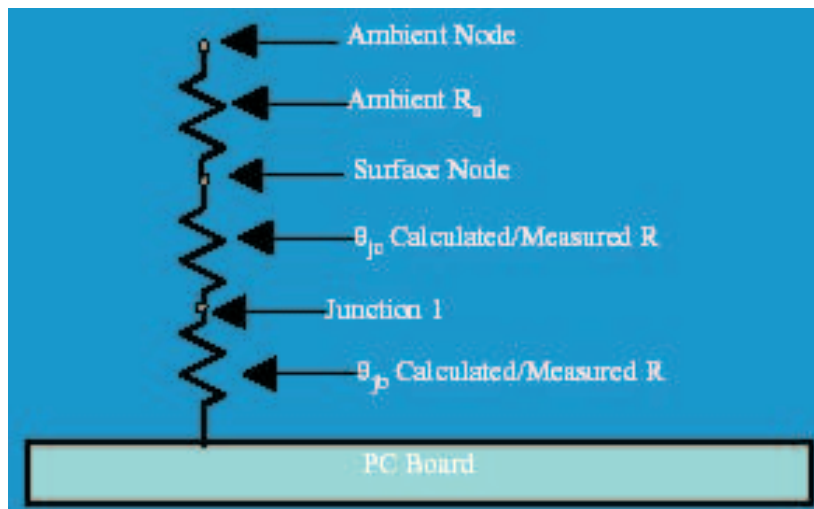


Figure 23. Thermal Resistance

## PACKAGING INFORMATION

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN65HVD53D       | PREVIEW               | SOIC         | D               | 14   | 50          | TBD                     | Call TI          | Call TI                      |
| SN65HVD53DR      | PREVIEW               | SOIC         | D               | 14   | 2500        | TBD                     | Call TI          | Call TI                      |
| SN65HVD54D       | PREVIEW               | SOIC         | D               | 14   | 50          | TBD                     | Call TI          | Call TI                      |
| SN65HVD54DR      | PREVIEW               | SOIC         | D               | 14   | 2500        | TBD                     | Call TI          | Call TI                      |
| SN65HVD55D       | PREVIEW               | SOIC         | D               | 14   | 50          | TBD                     | Call TI          | Call TI                      |
| SN65HVD55DR      | PREVIEW               | SOIC         | D               | 14   | 2500        | TBD                     | Call TI          | Call TI                      |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## PACKAGING INFORMATION

| Orderable Device | Status <sup>(1)</sup> | Package Type | Package Drawing | Pins | Package Qty | Eco Plan <sup>(2)</sup> | Lead/Ball Finish | MSL Peak Temp <sup>(3)</sup> |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN65HVD53D       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD53DG4     | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD53DR      | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD53DRG4    | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD54D       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD54DG4     | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD54DR      | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD54DRG4    | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD55D       | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD55DG4     | ACTIVE                | SOIC         | D               | 14   | 50          | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD55DR      | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |
| SN65HVD55DRG4    | ACTIVE                | SOIC         | D               | 14   | 2500        | Green (RoHS & no Sb/Br) | CU NIPDAU        | Level-1-260C-UNLIM           |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

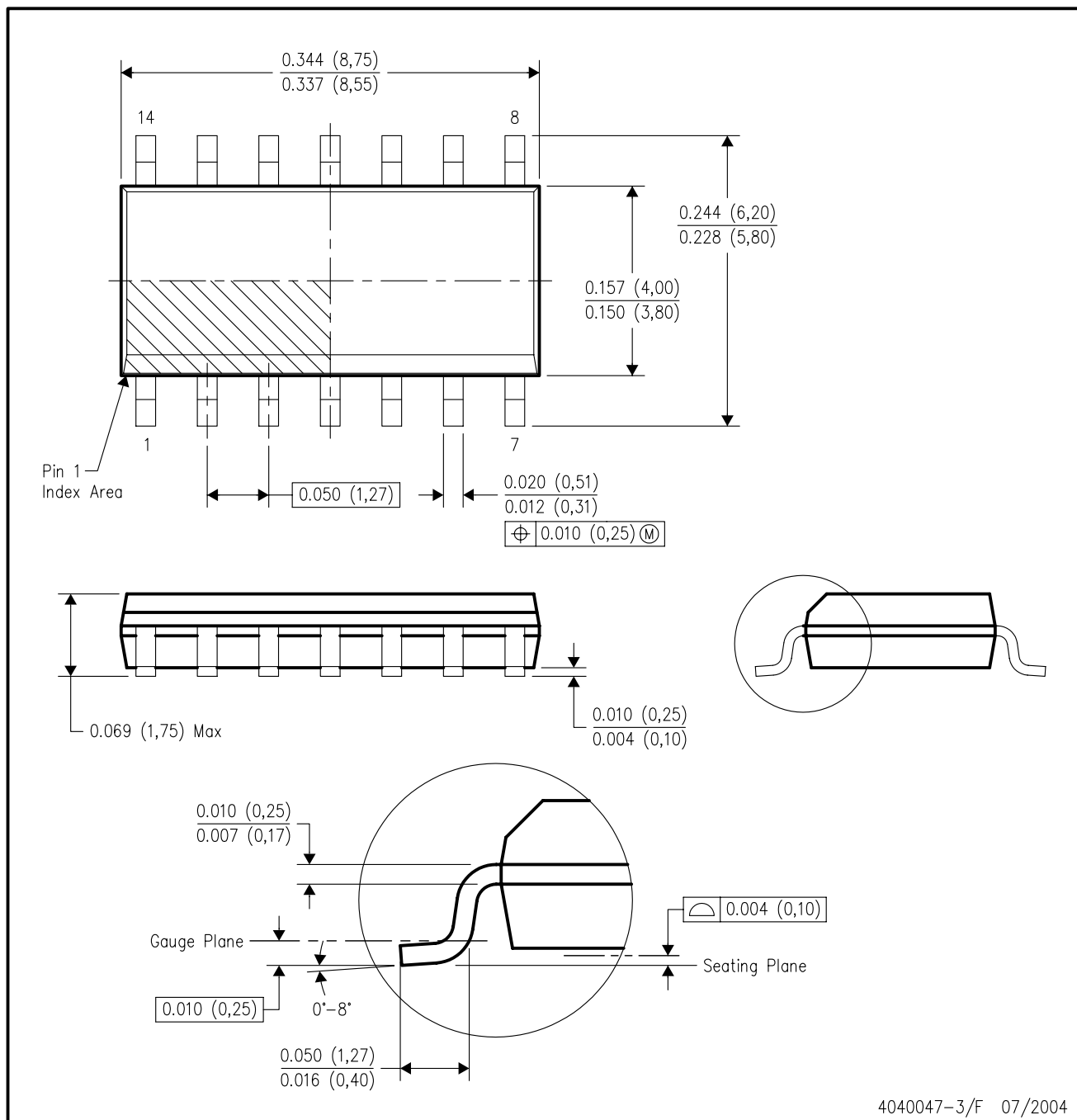
<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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## D (R-PDSO-G14)

## PLASTIC SMALL-OUTLINE PACKAGE



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